&TDK

TLA-6T207C(-T) 10/100BASE-TX

FEATURES

- · Lead free product.
- Can be mounted with lead-free solder (250°C max.).
- 14-pin(1.27mm pitch) SMD package.
- Low profile (H)2.2mm max. for note PC application.
- Excellent common mode noise suppression.
- Inductance is 350µH or greater (f=100kHz, DC bias=8mA).
- Using the high-quality and wide-band ferrite cores for LAN.
- Packaging specification is taping and bulk(TLA-6T207C-T: Tape and reel, TLA-6T207C: Bulk).

SHAPES AND DIMENSIONS



RECOMMENDED PC BOARD PATTERN



ELECTRICAL CHARACTERISTICS

Part No.	Turns ratio 132:14/12 657:9108	Inductance (μH)min. [DC bias 8mA, 100kHz] ⑭-⑬ ⑨-⑧	Insertion loss (dB)max. [0.1 to 100MHz] ①2-砷⑬ ⑨⑧-⑥⑦	Inter-winding stray capacitance (pF)max.[100kHz] ①②-⑭⑬ ⑥⑦-⑨⑧
	1CT:1CT	350	1	25
TLA-6T207C(-T)	1CT:1CT	350	1	25

• Ta=25°C

GENERAL SPECIFICATIONS

Pulse transformer		2	
Common-mode choke		2	
Port		1	
Tomporatura rangoa	Operating	0 to +70°C	
Temperature ranges	Storage	–40 to +85°C	
Withstanding voltage		Erms:1500V[60s]	
withstanding voltage		Enns. 1500V[608]	

CIRCUIT DIAGRAM





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PACKAGING STYLES

Quantity: 1500pieces/reel

TAPE DIMENSIONS



REEL DIMENSIONS



RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING



- Temperature is measured at the terminal portion of product (Using thermocoupler for measurement).
- This profile is reference data we recommend. Please check in your actual process.
- For reliable soldering, the thickness of solder paste screen should be over the terminal co-planality.
- The cutted end of terminal has no plating(out of subject of solder ability).

Dimensions in mm





RECOMMENDED STORE CONDITION

The product is packaged by Anti-humid Al bag, in order to keep a good solder ability condition and resistance to soldering heat for products.

- Before aluminum bag opening Temperature range: +5 to +40°C Humidity: 90(%)RH max. Storage period: 1year
- After aluminum bag opening Temperature range: +5 to +30°C Humidity: 60(%)RH max. Storage period: 1week